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2SK2225

Silicon N-Channel MOS FET



ADE-208-140 (Z) 1st. Edition Aug. 1993

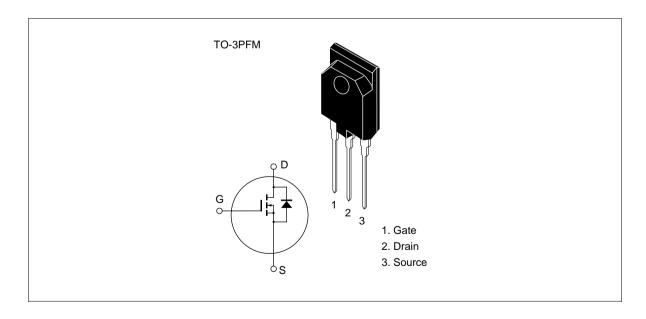
Application

High speed power switching

Features

- High breakdown voltage ($V_{DSS} = 1500 \text{ V}$)
- High speed switching
- Low drive current
- No Secondary Breakdown
- Suitable for Switching regulator, DC-DC converter

Outline



2SK2225

Absolute Maximum Ratings ($Ta = 25^{\circ}C$)

Item	Symbol	Ratings	Unit	
Drain to source voltage	V _{DSS}	1500	V	
Gate to source voltage	$V_{\sf GSS}$	±20	V	
Drain current	I _D	2	А	
Drain peak current	I _{D(pulse)} *1	7	Α	
Body to drain diode reverse drain current	I _{DR}	2	А	
Channel dissipation	Pch*2	50	W	
Channel temperature	Tch	150	°C	
Storage temperature	Tstg	-55 to +150	°C	

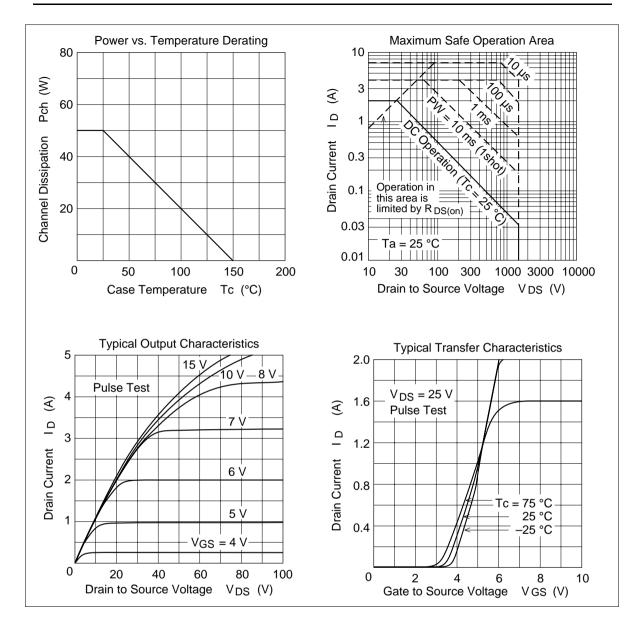
Notes 1. PW 10 µs, duty cycle 1 %

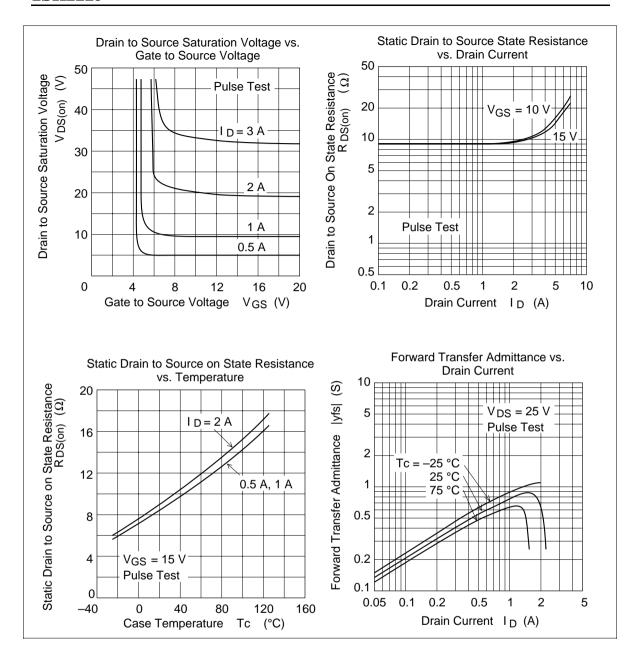
2. Value at Tc = 25 °C

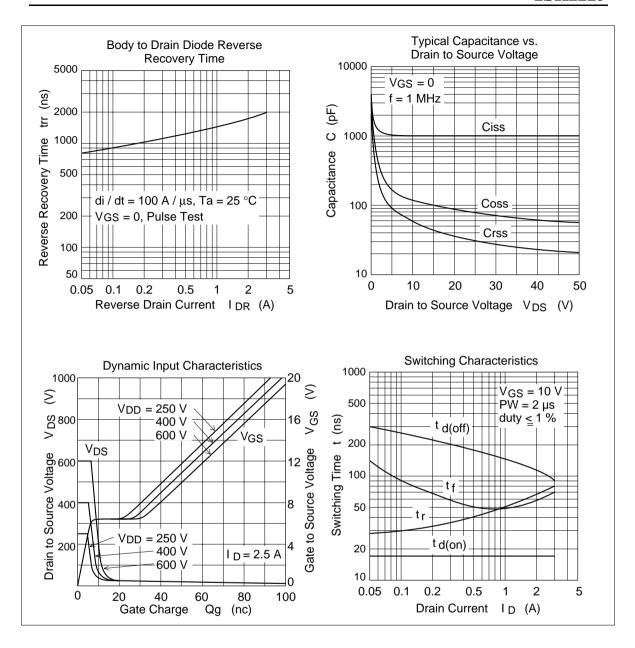
Electrical Characteristics ($Ta = 25^{\circ}C$)

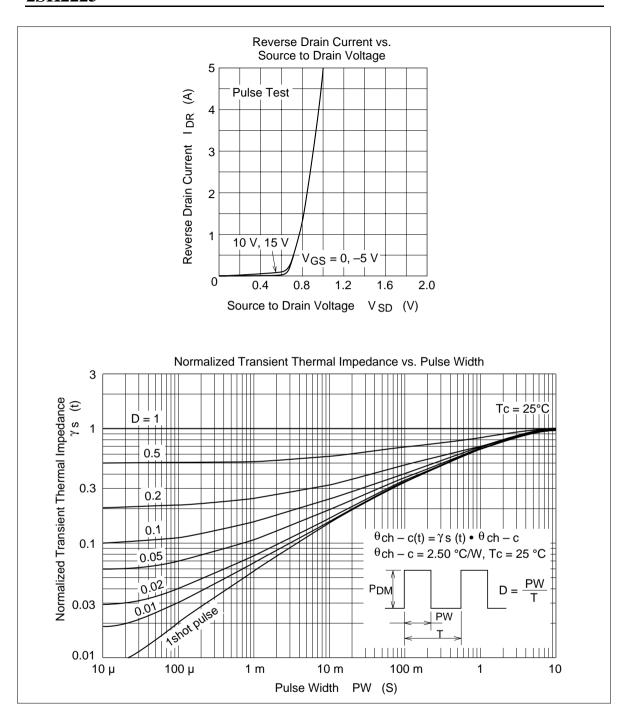
Item	Symbol	Min	Тур	Max	Unit	Test conditions
Drain to source breakdown voltage	$V_{(BR)DSS}$	1500	_	_	V	$I_D = 10 \text{ mA}, V_{GS} = 0$
Gate to source leak current	I _{GSS}	_	_	±1	μA	$V_{GS} = \pm 20 \text{ V}, V_{DS} = 0$
Zero gate voltage drain current	I _{DSS}	_	_	500	μΑ	V _{DS} =1200 V, V _{GS} = 0
Gate to source cutoff voltage	$V_{GS(off)}$	2.0	_	4.0	V	$I_{D} = 1 \text{ mA}, V_{DS} = 10 \text{ V}$
Static drain to source on state resistance	R _{DS(on)}	_	9	12		$I_D = 1 A$ $V_{GS} = 15 V^{*1}$
Forward transfer admittance	y _{fs}	0.45	0.75	_	S	I _D = 1 A V _{DS} = 20 V* ¹
Input capacitance	Ciss	_	990	_	pF	V _{DS} = 10 V
Output capacitance	Coss	_	125	_	pF	$V_{GS} = 0$
Reverse transfer capacitance	Crss	_	60	_	pF	f = 1 MHz
Turn-on delay time	t _{d(on)}	_	17	_	ns	I _D = 1 A
Rise time	t _r	_	50	_	ns	V _{GS} = 10 V
Turn-off delay time	t _{d(off)}	_	150	_	ns	$R_{L} = 30$
Fall time	t _f	_	50	_	ns	
Body to drain diode forward voltage	V_{DF}	_	0.9	_	V	$I_F = 2 A, V_{GS} = 0$
Body to drain diode reverse recovery time	t _{rr}		1750		ns	$I_F = 20 \text{ A}, V_{GS} = 0,$ $di_F / dt = 100 \text{ A} / \mu \text{s}$

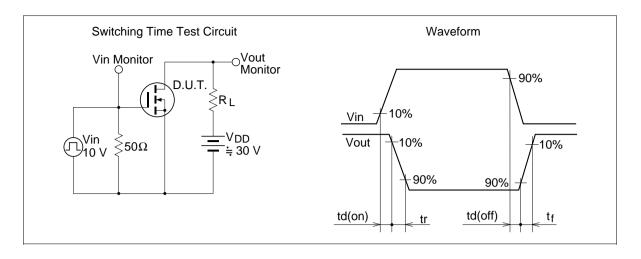
Note 1. Pulse Test



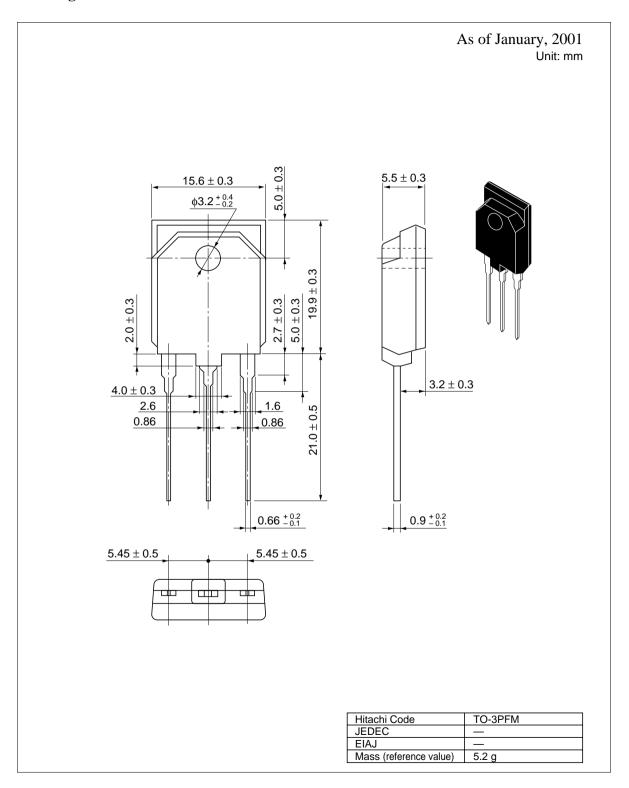








Package Dimensions





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